Department of Commerce
Ministry of Commerce and Industry,
Government of India

Packaging for Better Living

60 YEARS
DIAMOND JUBILEE
1966 - 2026

भारतीय पैकेजिंग संस्थान
Indian Institute of Packaging

INTERNATIONAL SUMMIT FOR PACKAGING INDUSTRY
ISPI
2027

7th INTERNATIONAL SUMMIT FOR PACKAGING INDUSTRY

Theme : Global Collaboration , innovation and Sustainability

5th - 6th
February, 2027

Bharat Mandapam,
New Delhi

Trade Brochure



Organized by
The Indian Institute of Packaging (IIP)

INVITATION TO SPONSORS

We are pleased to invite you to partner with us for the **7th International Summit for Packaging Industry (ISPI 2027)**, **organized by the Indian Institute of Packaging (IIP)**, to be held on **5-6 February 2027** at **Bharat Mandapam, New Delhi, India**.

ISPI is a premier platform that brings together industry leaders, researchers, academicians, technology providers and professionals to exchange knowledge, showcase innovations and explore opportunities across the packaging value chain.

ISPI 2027 - A Prime Platform for Industry Engagement

This edition will feature a dedicated Industry & Technology Exhibition, providing an opportunity to showcase products, technologies and solutions, connect research with industry, and foster collaboration across the packaging ecosystem.

The summit will address key areas such as sustainable and smart packaging, packaging materials, machinery and automation, with a focus on innovation, productivity and environmental responsibility.

We invite you to join us as a sponsor, exhibitor, or strategic partner, gaining high visibility and direct engagement with a diverse audience from industry, research and government.

Your participation will support innovation and capacity building in the packaging sector, while contributing to a landmark event for a stronger, more sustainable packaging ecosystem in India and beyond.

We look forward to your partnership and to welcoming you at ISPI 2027- where innovation in packaging drives a safer, smarter and more sustainable tomorrow.

Prof. (Dr.) Tanweer Alam
Addl. Director & RO, IIP – Delhi,
In-charge, IIP – Lucknow,
Convener, ISPI 2027



ABOUT THE **SUMMIT**

The International Summit for Packaging Industry (ISPI) brings together stakeholders from across the packaging value chain to examine emerging materials, conversion technologies, packaging machinery and automation. The summit focuses on improving productivity, reducing wastage and responding to the evolving requirements of packaging user industries and modern consumers.

The programme is designed to encourage exchange between industry professionals, researchers, technology providers, policymakers and the wider packaging community. The official event information highlights the Packaging 5S-Ai framework: Safe, Secure, Standardised, Smart, Sustainable and Artificial Intelligence-enabled packaging.

The Packaging 5S-Ai Framework

FOCUS AREA	SCOPE
Safe Packaging	Packaging materials and systems that support product safety and global compliance.
Secure Packaging	Product protection, security features and safer shipping and delivery.
Standardised Packaging	Standards that support product integrity, cost optimisation and reduced carbon footprints.
Smart Packaging	Intelligent packaging, connected solutions and technologies that monitor packaging performance.
Sustainable Packaging	Sustainable materials, circular approaches and emerging low-waste innovations.
Artificial Intelligence	AI-enabled design, predictive quality, defect detection, automation and supply-chain optimisation.

Who Should Participate

- Packaging material manufacturers and converters
- Packaging machinery, automation and technology providers
- Food, beverage, pharmaceutical, cosmetic and other packaging user industries
- Logistics, e-commerce and supply-chain organisations
- Research institutions, universities, startups and packaging professionals
- Government bodies, standards organisations and industry associations

KEY FOCUS AREAS & EVENT SNAPSHOT

A platform for business connections, technology exchange and packaging innovation.

KEY FOCUS AREA	COVERAGE
Sustainable & Circular Packaging	Materials, recycling, circularity and waste reduction.
AI & Digital Transformation	Predictive quality, digital systems and intelligent operations.
Smart & Intelligent Packaging	Sensors, smart labels, connected packaging and product monitoring.
Advanced Manufacturing & Technologies	Conversion technologies, machinery, automation and production.
E-commerce & Supply Chain Solutions	Packaging for fulfilment, shipping, storage and delivery.
Policy, Standards & Global Trends	Compliance, standardisation and international developments.

What to Expect

KEY FOCUS AREA	COVERAGE
1,500+	Delegates
120+	Eminent speakers
25+	Countries represented
80+	Exhibitors & partners
10+	Knowledge sessions & workshops
Cross-sector	Academia, industry & policy interactions

Concurrent Knowledge & Innovation Platforms

- IIP Packathon – a platform for packaging startups and innovators to present ideas, product concepts and solutions.
- Research Conclave – a platform for students, researchers and scientists to present packaging research and encourage academia–industry collaboration.

PARTNERSHIP OPPORTUNITIES

CONFERENCE PARTNER

₹12,00,000 + 18% GST

Benefits to the Sponsor

- ➤ Logo on the backdrop in the main conference hall.
- ➤ Logo on all conference signages as Conference Partner.
- ➤ Acknowledgement on the ISPI 2027 website as Conference Partner.
- ➤ Full-colour page ad in technical souvenir (to be provided by sponsor).
- ➤ 10 free Delegates.
- ➤ Technology Presentation during a keynote session break.

PLATINUM PARTNER

₹10,00,000 + 18% GST

Benefits to the Sponsor

- ➤ Logo on the backdrop in the main conference hall.
- ➤ Logo on all conference signages as Platinum Partner.
- ➤ Acknowledgement on the ISPI 2027 website as Platinum Partner.
- ➤ Full-colour page ad in technical souvenir (to be provided by sponsor).
- ➤ 8 free Delegates.
- ➤ Technology Presentation during a keynote session break.

GOLD PARTNER

₹8,00,000 + 18% GST

Benefits to the Sponsor

- ➤ Logo on the backdrop in the main conference hall.
- ➤ Logo on all conference signages as Gold Partner.
- ➤ Acknowledgement on the ISPI 2027 website as Gold Partner.
- ➤ Full-colour page ad in technical souvenir (to be provided by sponsor).
- ➤ 6 free Delegates.
- ➤ Technology Presentation during a keynote session break.

SILVER PARTNER — ₹6,00,000 + 18% GST

Benefits to the Sponsor

- ➤ Logo on the backdrop in the main conference hall.
- ➤ Logo on all conference signages as Silver Partner.
- ➤ Acknowledgement on the ISPI 2027 website as Silver Partner.
- ➤ Full-colour page ad in technical souvenir (to be provided by sponsor).
- ➤ 5 free Delegates.

BRONZE PARTNER — ₹4,00,000 + 18% GST

Benefits to the Sponsor

- ➤ Logo on the backdrop in the main conference hall.
- ➤ Logo on all conference signages as Bronze Partner.
- ➤ Acknowledgement on the ISPI 2027 website as Bronze Partner.
- ➤ Full-colour page ad in technical souvenir (to be provided by sponsor).
- ➤ 3 free Delegates.

EXHIBITION STALL SPONSORSHIP — ₹3,00,000 + 18% GST

Benefits to the Sponsor

- ➤ Logo on the backdrop in the main conference hall.
- ➤ Logo on all conference signages as Exhibition Stall Sponsorship.
- ➤ Acknowledgement on the ISPI 2027 website as Exhibition Stall Sponsorship.
- ➤ Full-colour page ad in technical souvenir (to be provided by sponsor).
- ➤ 2 free Delegates.

Partnership Benefits

- ➤ Brand visibility through the conference brochure, technical souvenir and event backdrop, as applicable to the selected category.
- ➤ Opportunity to engage with delegates, speakers, exhibitors and stakeholders from the packaging ecosystem.
- ➤ Speaker participation and complimentary delegate passes as specified in the partnership matrix.

DEDICATED SPONSORSHIP OPPORTUNITIES

Support key summit experiences and connect your brand with participating delegates.

SPONSORSHIP CATEGORY	TARIFF	COMPLIMENTARY BENEFITS
Gala Dinner	₹10,00,000 + 18% GST	10 free delegates and speaker slot free
Lunch	₹5,00,000 + 18% GST	6 free delegates and speaker slot free
Tea / Coffee / Snacks	₹3,00,000 + 18% GST	3 free delegates
Delegation Kit	₹2,00,000 + 18% GST	3 free delegates

ADVERTISING IN THE TECHNICAL SOUVENIR

Promote your organisation, products and services through the summit souvenir.

POSITION IN SOUVENIR	ADVERTISEMENT CHARGES
Centre Spread (Colour)	₹1,00,000 + 18% GST
Back Cover (Colour)	₹60,000 + 18% GST
Inside Covers (Colour)	₹50,000 + 18% GST
Inside (Colour)	₹25,000 + 18% GST

Artwork and submission: Advertisement artwork specifications, submission deadlines and file requirements may be confirmed with the conference manager.

Why Advertise

- Place your brand in front of delegates and professionals from the packaging sector.
- Highlight products, services, technologies and company capabilities.
- Support visibility alongside the summit's technical and industry programme.

Sponsorship Enquiry

Organisations interested in any of the above opportunities may indicate their preferred category in the response form at the end of this brochure. Availability and activation details can be coordinated with the official conference manager.

EXHIBITION STALL & SHELL SCHEME

Illustrative stall layout supplied for the ISPI 2027 trade brochure.



Illustrative exhibition stall. Fascia branding can be customised with the exhibitor name and stall number.

Components Identified in the Stall Illustration

COMPONENT	DESCRIPTION
White Polykem Panel	Partition wall panels
Fascia	Exhibitor name and stall number
Folding Chair	Seating
Carpet Flooring	Stall floor covering
Waste Basket	Waste disposal

Important: *The image is illustrative. Final stall specifications, inclusions, power requirements and furniture allocation should be confirmed in the exhibitor allotment / contract.*

SPONSORSHIP & EXHIBITION
RESPONSE FORM

COMPONENT	DESCRIPTION	MARK THE BOX
Conference Partner	₹12,00,000 + 18% GST	
Platinum Partner	₹10,00,000 + 18% GST	
Gold Partner	₹8,00,000 + 18% GST	
Silver Partner	₹6,00,000 + 18% GST	
Bronze Partner	₹4,00,000 + 18% GST	
Exhibition Stall Sponsorship	₹3,00,000 + 18% GST	
Gala Dinner	₹10,00,000 + 18% GST	
Lunch	₹5,00,000 + 18% GST	
Tea / Coffee / Snacks	₹3,00,000 + 18% GST	
Delegation Kit	₹2,00,000 + 18% GST	
Advertisement	Please specify position: _____	

Bank Details

Beneficiary Name: **INDIAN INSTITUTE OF PACKAGING, DELHI CENTRE**	
Bank: **STATE BANK OF INDIA**	A/c No.: **30460312467**
Branch Address: **UDYOG SADAN, 419, PATPARGANJ INDUSTRIAL ESTATE, DELHI-110092**	IFS Code: **SBIN0010553**

Note:

- *The bank receipt of payment must be forwarded to the conference secretariat by email for confirmation*
- *Bank charges are the responsibility of the payee.*
- *Applications for Sponsorship and / or Exhibition must be made in writing.*
- *Amount mentioned is Exclusive of 18% GST (as applicable).*

SPONSORSHIP & EXHIBITION
RESPONSE FORM

Company /Organization:.....

is interested in the sponsorship(s).....

in the ISPI 2027 at Bharat Mandapam, New Delhi, India. We understand that in order to secure a sponsorship, a deposit of 50% of the cost of our first choice must be with this form. All application will be considered for the allocation on a first come, first served basis.

Name of the company .....

Contact person in Delhi..... Mobile no.....

Designation.....

Address (Delhi office).....

Telephone no..... Fax No.....

E-mail .....

Address (Head Office) .....

.....

Contact person in (Head Office) ..... Mobile no. .....

Designation .....

Address (Head office) .....

Telephone No.....Fax No .....

E-mail I.....

We confirm our participation (The details are as above) Please mark the box (es) of sponsorship of your choice.

Packaging Secretariat
CONVENER / ORGANISING SECRETARY

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